









PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ➤ 2016 0.52t
- ► Warm White 3200K

NOW63S69 (High TLCI)





2016 EMC Series





FEATURES:

Package: Top View EMC White Package

Forward Current: 60mA Forward Voltage (typ.): 2.9V Luminous Flux (typ.): 19lm@60mA

Colour: Warm White

Colour Temperature (CCT): 3200K

Viewing Angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+105°C Storage Temperature: -40~+105°C

CRI/TLCI (min.): 95/95

Grouping Parameters:

Forward Voltage

Luminous Flux

CIE Chromaticity

Soldering Methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with max.5000/reel, ø165mm (6.5")

APPLICATIONS:

- **General Lighting**
- Museum Lighting
- Portable Lighting
- **Commercial Lighting**
- **Indoor Lighting**
- Backlight for LCD

Release Date: 18 May 2023 Version: A1.0



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	150	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	I _{PF}	225	mA
Power Dissipation	P _D	480	mW
Reverse Voltage	V_R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	120	°C
Thermal Resistance (Junction to Solder Point)	R _{THJS}	38	°C/W
Operating Temperature	T_OPR	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	T _{SOL}	230/260 for 10S	°C
Colour Rendering Index	CRI	min.95	
Television Lighting Consistency Index	TLCI	min.95	

Electrical & Optical Characteristics (Ta=25°C)

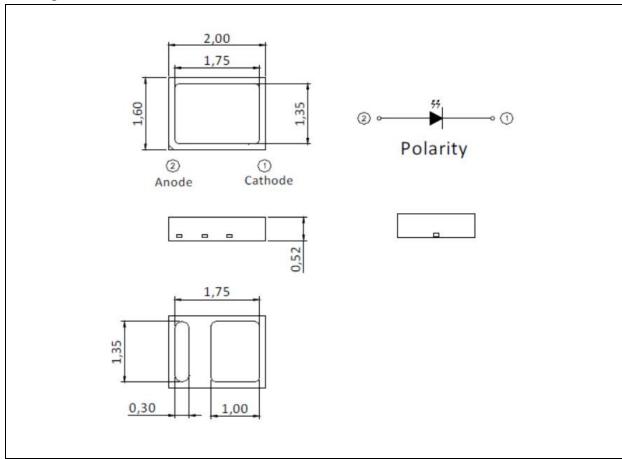
Parameter	Symbol	Values			Unit	Test	
Parameter	Зуппрог	Min.	Тур.	Max.	Offic	Condition	
Forward Voltage	V_{F}	2.8	2.9	3.2	V	I _F =60mA	
Luminous Flux	Ф۷	16	19	22	lm	I _F =60mA	
Chromaticity Coordinates	Х		0.4263			I _F =60mA	
	Υ		0.4003				
Colour Temperature	ССТ		3200		К	I _F =60mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =60mA	

^{1.} Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.1V



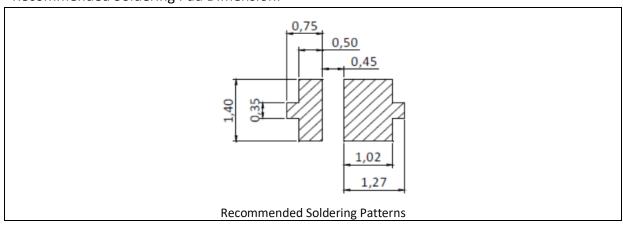
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 60mA):

Code	Min.	Max.	Unit	
B1	2.8	2.9		
C1	2.9	3.0	V	
D1	3.0	3.1		
E1	3.1	3.2		

Luminous Flux Classifications ($I_F = 60 \text{mA}$):

Code	Min.	Max.	Unit	
1D	16	18		
1E	18	20	lm	
1F	20	22		



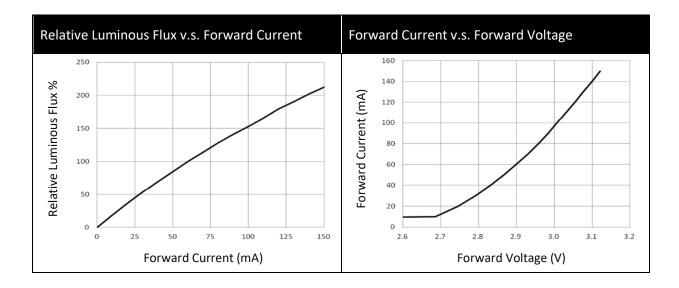
CIE CHROMATICITY DIAGRAM:

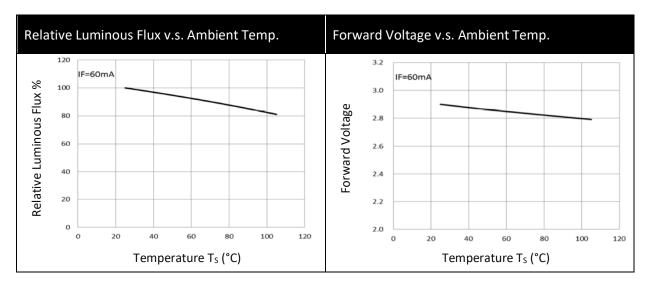
Chromaticity Coordinates Classifications (I_F = 60mA):

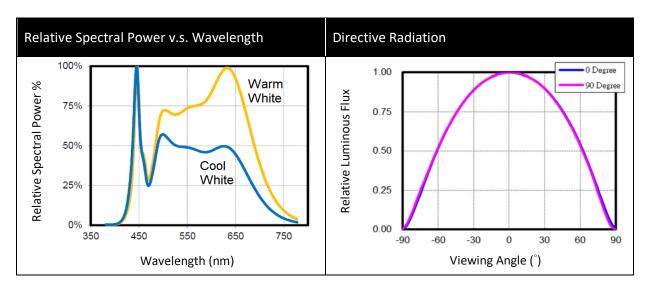
	Code	Centre		Radius		Angle
a /)		Х	Υ	а	b	Φ
D 0	32SC5	0.4263	0.4003	0.014675	0.006850	53.43



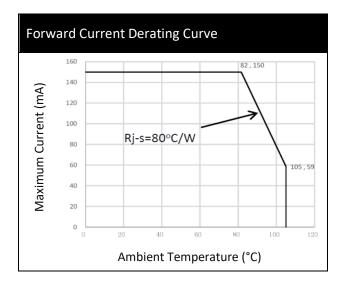
ELECTRO-OPTICAL CHARACTERISTICS:







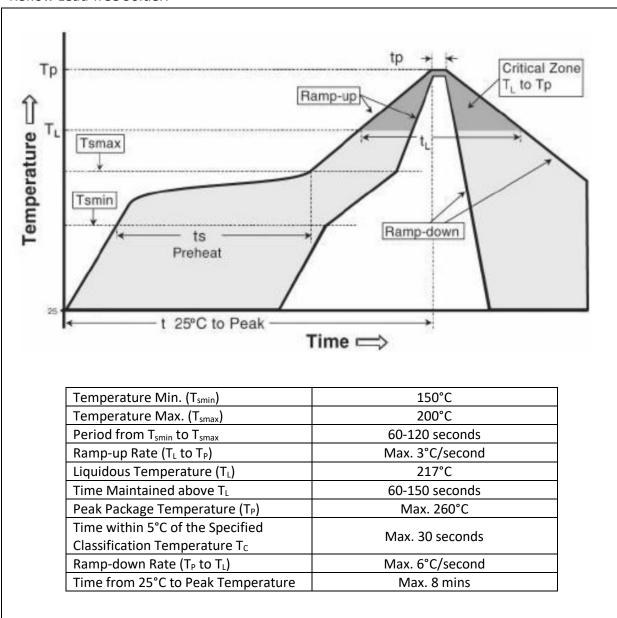






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



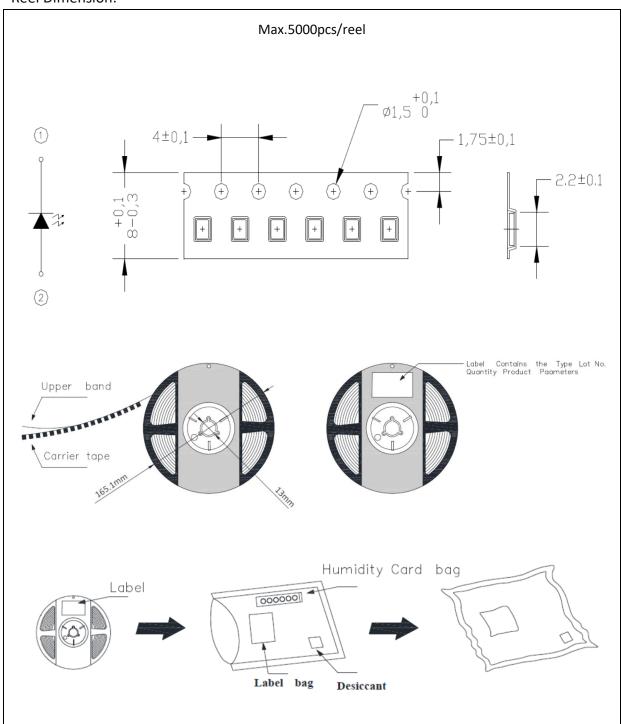
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

• Humidity: 60% R.H. Max.

• Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

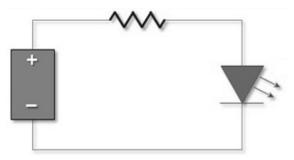
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	18/05/2023	Datasheet set-up.